

ESPI Current Report

Number: 8/2021
Date: 2 June 2021
Company: XTPL S.A., a joint stock company with its registered office in Wrocław

Topic: Submission of a patent application concerning precise filling of micrometric cavities with polymer

Legal basis: Article 17(1) MAR – inside information

Contents of the Report: The Management Board of XTPL S.A. (“Issuer”, “Company”, “XTPL”) hereby announces that on 1 June 2021, the Issuer submitted a patent application with the United States Patent and Trademark Office (USPTO) relating to the XTPL-developed technological solution (“Method”) for precise filling of micrometric cavities with polymer.

The method described in the application is particularly important for the manufacture of modern semiconductor devices. The advantage of XTPL’s Method is that the cavity is filled in a homogeneous and precise manner (without spilling), and that no cracks are formed in the process. The XTPL printing system can be used to perform the filling.

The Issuer’s Management Board has decided that the submission of the said patent application is inside information, as in the case of an entity operating in the deep-tech sector, effective protection by the Company of its intellectual and industrial property, a factor which influences the Company value, is one of the elements that investors may take into account when making decisions about the Issuer’s financial instruments.

In the opinion of the Company’s Management Board, ensuring an appropriate level of security and extensive patent protection (both in the form of obtained patents and submitted patent applications) is a significant competitive advantage for the Issuer and may contribute to ensuring an appropriate bargaining position when negotiating commercial contracts.

Accordingly, in the Management Board’s opinion, the information on submission of the patent application meets the criteria of inside information within the meaning of Article 7(1) MAR.

At the same time, the Company's Management Board advises that as of publication of this report, information on submission of subsequent patent applications will be each time made available to the public.

Signatures of the Company's representatives:

Jacek Olszański
MANAGEMENT BOARD MEMBER